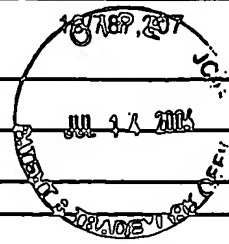


## INFORMATION DISCLOSURE CITATION

Atty. Docket No. 04329.3253	Application No.
Applicant Shinya TAKYU et al.	
Filing Date February 27, 2004	Group: 2812



U.S. PATENT DOCUMENTS							
Examiner Initial*	Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate	
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2/	61-112345	5/30/86	Japan			No	
4/	2001-144037	5/25/01	Japan			No	

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3/	IIJIMA, T. et al., "SEMICONDUCTOR DEVICE OBTAINED BY DIVIDING SEMICONDUCTOR WAFER BY USE OF LASE DICING TECHNIQUE AND METHOD OF MANUFACTURING THE SAME", Application No. 10/418,274, Filed April 18, 2003

Examiner H. P. Kumar	Date Considered 1/5/06
*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	
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# **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

(Use as many sheets as necessary)

Sheet

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First Named Inventor

Shinya TAKYU et al

Art Unit

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Kevin M. Picardat

Attorney Docket Number

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## **U.S. PATENTS AND PUBLISHED U.S. PATENT APPLICATIONS**

Examiner Initials	Cite No. <sup>1</sup>	Document Number	Issue or Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code <sup>2</sup> (if known)			
		US-			
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**Note:** Submission of copies of U.S. Patents and published U.S. Patent Applications is not required.

## **FOREIGN PATENT DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Translation <sup>9</sup>
		Country Code <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (if known)				
W		CN 1340855 A	03/20/2002			
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W		JP 63-293939	11/30/1988			

## **NON PATENT LITERATURE DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	Translation <sup>9</sup>
W		Official Action from the State Intellectual Property Office of the People's Republic of China dated September 16, 2005, and English language translation of same.	Yes

Examiner  
Signature

K. Picardat

Date  
Considered

11/5/06

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